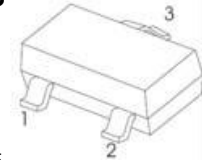


## Plastic-Encapsulate MOSFETS

P-Channel 20-V(D-S) MOSFET

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
-20 V	50mΩ@-4.5V	-4A
	60mΩ@-2.5V	
	100mΩ@-1.8V	

SOT-23



1. GATE
2. SOURCE
3. DRAIN

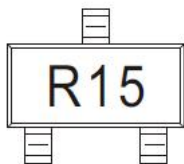
### FEATURE

- ⌘ Excellent  $R_{DS(ON)}$ , low gate charge, low gate voltages
- ⌘ ESD Protected up to 2kV

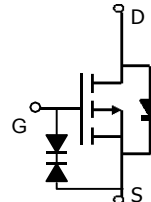
### APPLICATION

- ⌘ Load switch and in PWM applications

### MARKING



### Equivalent Circuit



### Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	±8	
Continuous Drain Current ( $t \leq 10s$ )	$I_D$	-4.0	A
Maximum Power Dissipation ( $t \leq 10s$ )	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357	$^\circ\text{C}/\text{W}$
Operating Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~+150	$^\circ\text{C}$

## MOSFET ELECTRICAL CHARACTERISTICS

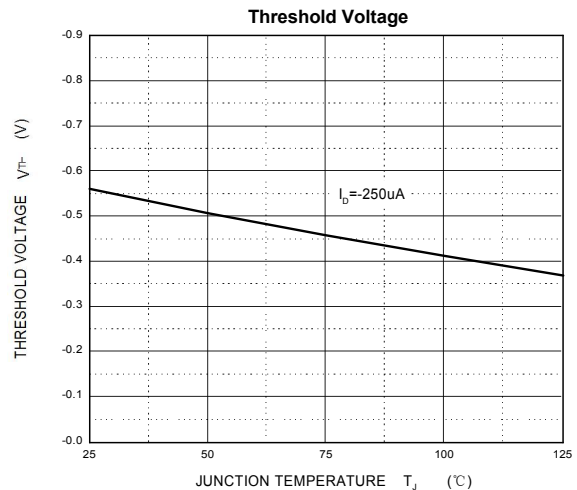
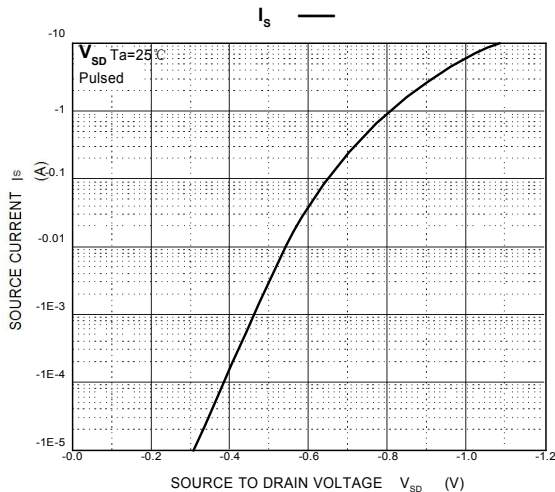
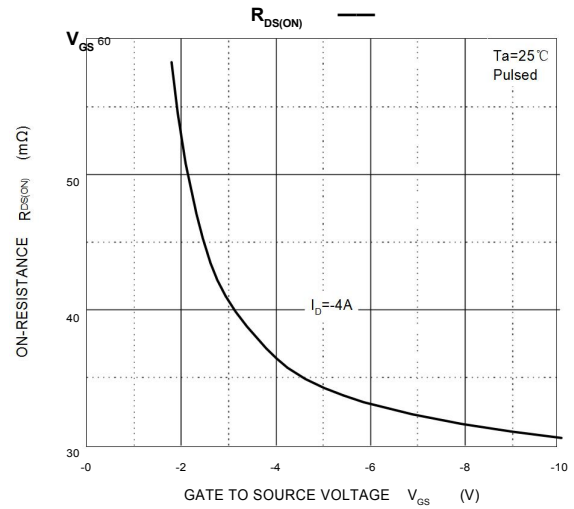
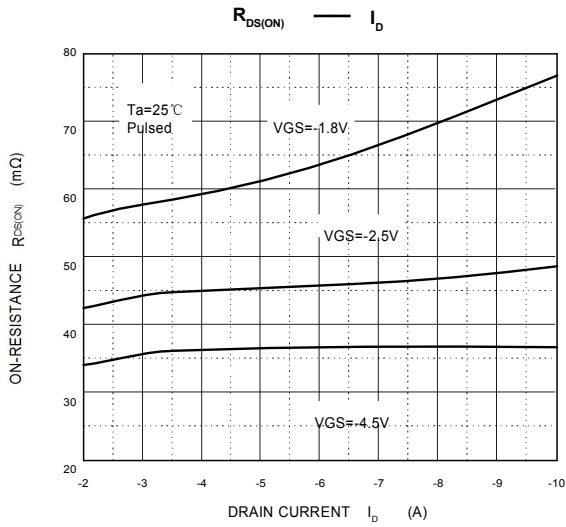
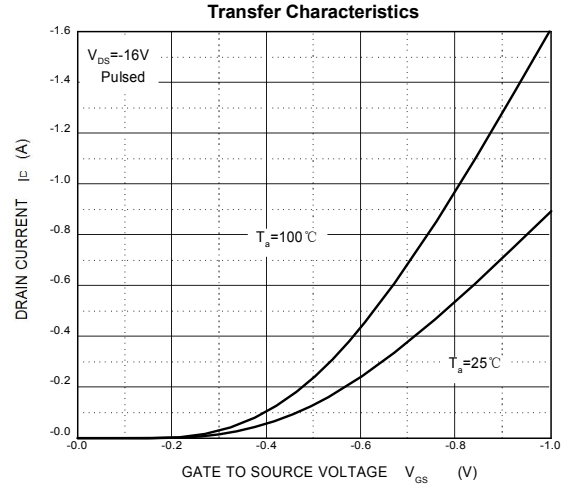
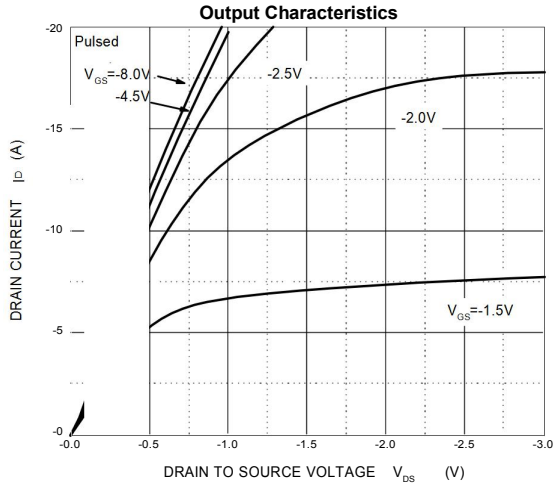
$T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Static Parameters</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20			V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.3	-0.56	-1	
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 8V$			$\pm 10$	$\mu A$
		$V_{DS} = 0V, V_{GS} = \pm 4.5V$			$\pm 1$	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -16V, V_{GS} = 0V$			-1	
Drain-source on-state resistance(note1)	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -4A$		0.037	0.050	$\Omega$
		$V_{GS} = -2.5V, I_D = -4A$		0.045	0.060	
		$V_{GS} = -1.8V, I_D = -2A$		0.080	0.100	
Forward transconductance(note2)	$g_{FS}$	$V_{DS} = -5V, I_D = -4A$	8			S
Body diode voltage(note2)	$V_{SD}$	$I_S = -1A, V_{GS} = 0V$			-1	V
<b>Dynamic Parameters (note3)</b>						
Input capacitance	$C_{iss}$	$V_{DS} = -10V, V_{GS} = 0V, f = 1MHz$		1450		pF
Output capacitance	$C_{oss}$		205			
Reverse transfer capacitance	$C_{rss}$		160			
Gate resistance	$R_g$	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		6.5		$\Omega$
<b>Switching Parameters</b>						
Total gate charge	$Q_g$	$V_{DS} = -10V, V_{GS} = -4.5V, I_D = -4A$		17.2		nC
Gate-Source charge	$Q_{gs}$		1.3			
Gate-drain charge	$Q_{gd}$		4.5			
Turn-on delay time (note3)	$t_{d(on)}$	$V_{DS} = -10V, V_{GS} = -4.5V$ $R_{GEN} = 3\Omega, R_L = 2.5\Omega,$		9.5		ns
Turn-on rise time(note3)	$t_r$		17			
Turn-off delay time(note3)	$t_{d(off)}$		94			
Turn-off fall time(note3)	$t_f$		35			

**Notes:**

1. Repetitive rating, pulse width limited by junction temperature.
2. Pulse Test : Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
3. These parameters have no way to verify.

## Typical Characteristics

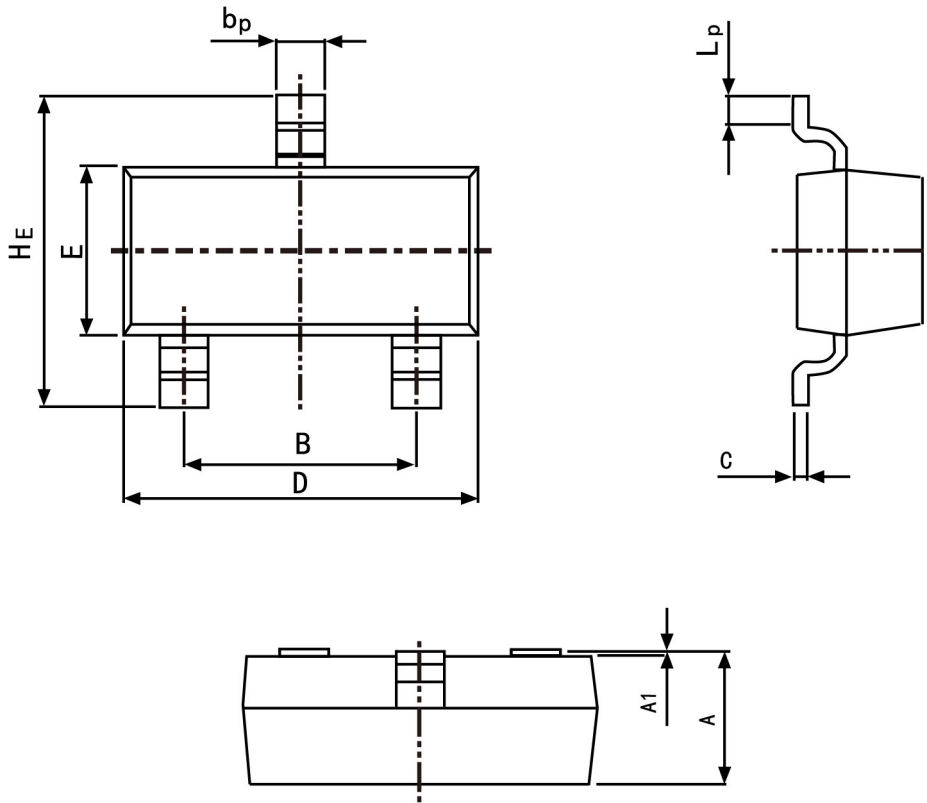




## PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



Symbol	Dimension in Millimeters	
	Min	Max
A	0.95	1.40
B	1.78	2.04
$b_p$	0.35	0.50
C	0.08	0.19
D	2.70	3.10
E	1.20	1.65
HE	2.20	3.00
$A_1$	0.100	0.013
$L_p$	0.20	0.50